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Part Number	ES2D
product family	ULTRA FAST RECOVERY RECTIFIERS
package type	HSMA
VRM(PRV)	200V
Ifsm	50A
IF(AV)	2.0A
@Vf	0.975V
@If	2.0A
Trr	50nS
IR	5.0μA
@VR	200V
Package Qty	Tape : 3K/Reel, 48K/Ctn;

This product is listed under the following categories where you may find similar products:
[Diodes](#)
[Ultra Fast Recovery Rectifiers](#)



Micro Commercial Components

ES2A THRU ES2M

**2 Amp Ultra Fast
Recovery
Silicon Rectifier
50 to 1000 Volts**

Features

- Lead Free Finish/Rohs Compliant (Note1) ("P" Suffix designates Compliant. See ordering information)
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0 and MSL rating 1
- Easy Pick And Place
- High Temp Soldering: 260°C for 10 Seconds At Terminals
- Superfast Recovery Times For High Efficiency

Maximum Ratings

- Operating Temperature: -50°C to +150°C
- Storage Temperature: -50°C to +150°C
- Maximum Thermal Resistance; 20°C/W Junction To Lead

MCC Catalog Number	Device Marking	Maximum Recurrent Peak Reverse Voltage	Maximum RMS Voltage	Maximum DC Blocking Voltage
ES2A	ES2A	50V	35V	50V
ES2B	ES2B	100V	70V	100V
ES2C	ES2C	150V	105V	150V
ES2D	ES2D	200V	140V	200V
ES2G	ES2G	400V	280V	400V
ES2J	ES2J	600V	420V	600V
ES2K	ES2K	800V	560V	800V
ES2M	ES2M	1000V	700V	1000V

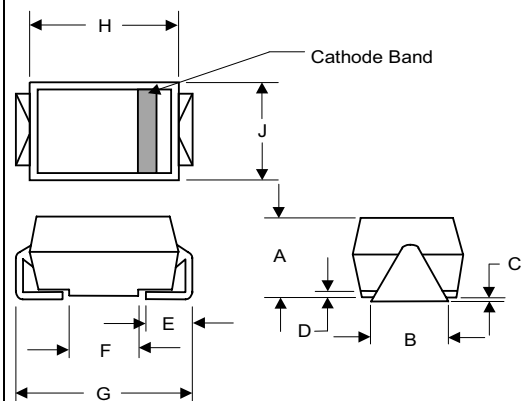
Electrical Characteristics @ 25°C Unless Otherwise Specified

Average Forward Current	$I_{F(AV)}$	2.0A	$T_J = 75^\circ\text{C}$
Peak Forward Surge Current	I_{FSM}	50A	8.3ms, half sine
Maximum Instantaneous Forward Voltage	V_F	ES2A-D 1.35V ES2G-J 1.70V ES2K-M	$I_{FM} = 2.0\text{A};$ $T_J = 25^\circ\text{C}^*$
Maximum DC Reverse Current At Rated DC Blocking Voltage	I_R	5 μA 150 μA	$T_J = 25^\circ\text{C}$ $T_J = 100^\circ\text{C}$
Maximum Reverse Recovery Time	T_{rr}	50ns 60ns 100ns	$I_F=0.5\text{A}, I_R=1.0\text{A},$ $I_{rr}=0.25\text{A}$
Typical Junction Capacitance	C_J	25pF	Measured at 1.0MHz, $V_R=4.0\text{V}$

*Pulse test: Pulse width 200 μsec , Duty cycle 2%

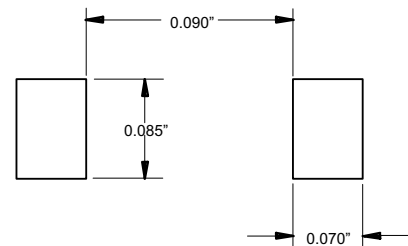
Note: 1. High Temperature Solder Exemptions Applied, see EU Directive Annex 7.

DO-214AC (HSMA) (High Profile)



DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	.078	.116	1.98	2.95	
B	.067	.089	1.70	2.25	
C	.002	.008	.05	.20	
D	---	.02	---	.51	
E	.035	.055	.89	1.40	
F	.065	.096	1.65	2.45	
G	.205	.224	5.21	5.69	
H	.160	.180	4.06	4.57	
J	.100	.112	2.57	2.84	

SUGGESTED SOLDER PAD LAYOUT





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Ordering Information

Device	Packing
(Part Number)-TP	Tape&Reel;3Kpcs/Reel

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